Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note: Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp. Customer Support Dept. April 1, 2003



BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

DESCRIPTION

M52742ASP is semiconductor integrated circuit for CRT display monitor

It includes OSD blanking, OSD mixing, retrace blanking, wide band amplifer, brightness control, uniformity function.

Main/sub contrast and OSD adjust function can be controlled by FC bus.

FEATURES

Freque	ency band width: RGB	200MHz (at -3dB)
. 10 (B) (F) (B)		80MHź
Input	:RGB	0.7VP-P (typ.)
	OSD	3VP-P minimum (positive)
	BLK (for OSD)	3VP-P minimum (positive)
	Retrace BLK	3VP-P minimum (positive)
Outpu	t :RGB	5.5VP-P (max.)
	OSD	5VP-P (max.)

- Main contrast and sub contrast can be controlled by I²C bus.
- · Include internal and external pedestal clamp circuit

STRUCTURE

Bipolar silicon monolithic IC

APPLICATION

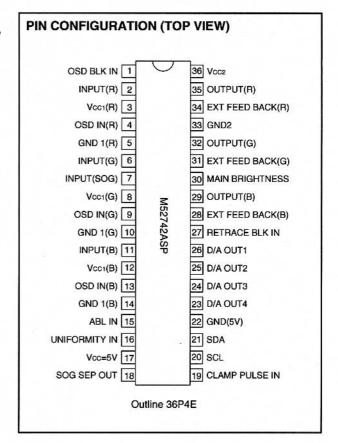
CRT display monitor

RECOMMENDED OPERATING CONDITION

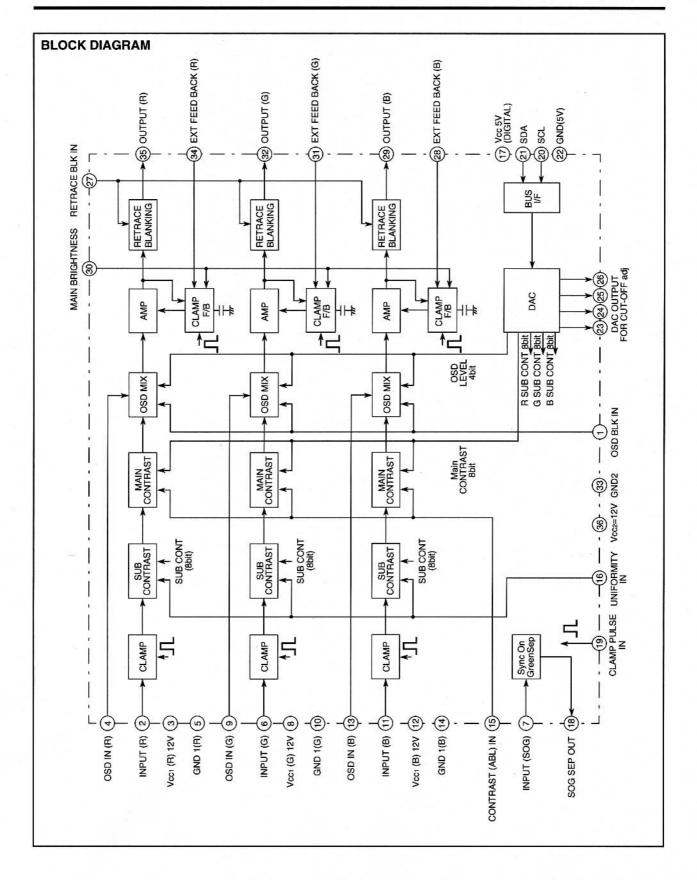
Supply voltage range	11.5 to 12.5V (V3, V8, V12, V36)
	4.5 to 5.5V (V17)
Rated supply voltage	12.0V (V3, V8, V12, V36)
	5.0V (V17)

MAJOR SPECIFICATION

Bus controlled 3ch video pre-amp with OSD mixing function and retrace blanking function



BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR



BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Symbol	Parameter	Ratings	Unit
VCC12	Supply voltage (pins 3,8,12,36)	13.0	V
Vcc5	Supply voltage (pin 17)	6.0	V
Pd	Power dissipation	2403	mW
Topr	Ambient temperature	-20 to +75	°C
Tstg	Storage temperature	-40 to +150	°C
Vopr12	Recommended supply 12	12.0	V
Vopr5	Recommended supply 5	5.0	V

ELECTRICAL CHARACTERISTICS (Vcc=12V, 5V, Ta=25°C, unless otherwise noted)

WW. 25 TO	Self May	Test				Input					TL age				В	US	C	ΓL (H)					Limits	3	Ever Dalls
Symbol	Parameter	point (s)	2,6,11 RGB in	1 OSD BLK	4,9,13 OSD in	19 CP in	27 ReT BLK	7 SOG in	16 UNI in	30 Bri- ght	15 ABL	00H Main cont		Sub con 2	Sub	OSE	05H BLK Adj	D/A	D/A	08H D/A OUT 3	1 09 1 D/ 1 OL	H OB	Min.	Тур.	Мах.	Unit
lcc1	Circuit current1	la	а	а	а	b SG5	а	а	а	4.0	5.0	FFH 255	FFH 255	FFH 255	FFH 255	0011	001	FFH 255	FFI- 255	FFI- 255		H 00		126	146	mA
lcc2	Circuit current2	lв	а	а	а	b SG5	а	а	а	4.0	5.0	See See								П			-	18	25	mA
Vomax	Output dynamic range	OUT	b SG2	а	а	b SG5	а	a	a	Vari able	5.0				П					П			6.0	8.0	-	V _{P-P}
Vimax	Maximum input	IN OUT	b SG2 Variable	а	а	b SG5	а	а	а	2.0	5.0	64H 100											1.6	-		Vp-P
Gv	Maximum gain	оит	b SG1	а	а	b SG5	a	a	a	2.0	5.0	FFH 255								\prod	П		16.5	17.7	19.4	dB
ΔGv	Relative max- imum gain	-			•	7.00	•	•	-	•													0.8	1.0	1.2	
Vc1	Main contrast control characteristics1	OUT	b SG1	а	а	b SG5	а	а	а	2.0	5.0	C8H 200											15.5	17.0	18.5	dB
ΔVc1	Main contrast control relative characteristics1	•	•	•			•	•	(4)	×.	(-41)	-											0.8	1.0	1.2	
Vc2	Main contrast control characteristics2	OUT	b SG1	а	а	b SG5	a	а	a	2.0	5.0	64H 100											9.5	11.0	12.5	dB
ΔVc2	Main contrast control relative characteristics2	5	6 7 0	•	•	•		•				·											0.8	1.0	1.2	-
Vсз	Main contrast control characteristics3	OUT	b SG1	а	а	b SG5	а	а	а	2.0	5.0	14H 20									2000		0.2	0.4	0.6	V _{P-P}
ΔVсз	Main contrast control relative characteristics3	*		-		-	•	•			•		V	V									0.8	1.0	1.2	
Vsc ₁	Sub contrast control characteristics1	OUT	b SG1	а	а	b SG5	а	а	а	2.0	5.0	FFH 255	C8H 200	C8H 200	C8H 200			200 V CO CO					16.0	17.5	19.0	dB
ΔVsc1	Sub contrast control relative characteristics1	- 2	14	•	84		212		14		(20)		·	121	-								0.8	1.0	1.2	23
Vsc2	Sub contrast control characteristics2	OUT	b SG1	а	а	b SG5	а	а	а	2.0	5.0	FFH 255	64H 100	64H 100	64H 100								12.0	13.5	15.0	dB
ΔVsc2	Sub contrast control relative characteristics2		•	•		(B)		•	٠		(1 8)		9 5 3		-								0.8	1.0	1.2	-
Vscs	Sub contrast control characteristics3	OUT	b SG1	а	а	b SG5	а	а	а	2.0	5.0	FFH 255	14H 20	14H 20	14H 20								1.5	1.9	2.2	V _{P-P}
ΔVscз	Sub contrast control relative characteristics3	-		•	78 4 8		-	•			•	-	-	-	-	V	Į,	I V	V	V			0.8	1.0	1.2	×



BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

ELECTRICAL CHARACTERISTICS (cont.)

		Test			,	Input		0.77		C volt					В	us	СТ	L(H)					ı	Limits		
Symbol	Parameter	point (s)	2,6,11 RGB in	1 OSD BLK	4,9,13 OSD in	19 CP in	27 ReT BLK	7 SOG in	16 UNI in	30 Bri- ght	15 ABL	00H Main cont	Sub	Sub con 2	Sub		05H BLK Adj		DVA	D/A	DV	H OB A IN EX	М	in.	Тур.	Мах.	Unit
VMSC	Main/sub contrast control characteristics	OUT	b SG1	а	а	b SG5	а	а	а	2.0	5.0	C8H 200	200 200	1 C81	C6H 200								3	3.5	4.1	4.7	Vp-p
∆VMSC	Main/sub contrast control relative characteristics	2	12	1	-	-	-	-	-	-		-	ï	-	-								0	8.0	1.0	1.2	-
ABL1	ABL control characteristics1	OUT	b SG1	а	а	b SG5	а	а	а	2.0	4.0	FFH 255	FFI- 255										4	1.2	5.0	5.8	VP-P
∆ABL1	ABL control relative characteristics1		14		1		-	-		2	3.												0	8.0	1.0	1.2	
ABL2	ABL control characteristics2	OUT	b SG1	а	а	b SG5	а	а	а	2.0	2.0												2	2.6	3.1	3.6	Vp-p
ABL2	ABL control relative characteristics2	-	16-		4	is a di	•	10		•	4												0	8.0	1.0	1.2	127
V _{B1}	Brightness control characteristics1	OUT	а	а	a	b SG5	а	а	а	4.0	5.0		Service of										3	3.3	3.7	4.1	V
ΔVB1	Brightness control relative characteristics1	•	1.4	4	20	2	152		4	-	(<u>*</u>												-(0.3	0	0.3	V
VB2	Brightness control characteristics2	оит	а	а	а	b SG5	а	а	а	2.0	5.0												1	.5	1.8	2.1	V
ΔVв2	Brightness control relative characteristics2	-	(15)		2	0		ē	ē														-(0.3	0	0.3	V
Vвз	Brightness control characteristics3	OUT	а	а	a	b SG5	a	а	а	1.0	5.0		ů										().7	0.9	1.1	V
ΔVвз	Brightness control relative characteristics3	-	-	•			-			-	. 6	V	434										-(0.3	0	0.3	V
Fc1	Frequency characteristics1 (f=50MHz)	OUT	b SG3	а	а	a 5V	а	а	a	Vari able	5.0	Va ria ble	Н										-2	2.0	0	2.5	dB
ΔFc1	Frequency relative characteristics1 (I=50MHz)	-	7.61	(-)			-		-	-		-	ļ		ı,	V	V	Į,	V	V			-1	.0	0	1.0	dB
Fc1'	Frequency characteristics1 (f=200MHz)	оит	b SG3	а	а	a 5V	а	а	а	Vari able	5.0	Va ria ble	255	(FF) 255	FFH 255	00H 0	00H 0	FFH 255	FFH 255	FFH 255		H 001	1 -3	3.0	0	3.0	dB
ΔFc1'	Frequency relative characteristics1 (I=200MHz)	-	100			-	-	-	-				П						П				-1	.0	0	1.0	dB
Fc2	Frequency characteristics2 (f=200MHz)	OUT	b SG3	а	а	a 5V	а	а	а	Vari able	5.0												-3	3.0	3.0	5.0	dB
ΔFc2	Frequency relative characteristics2 (f=200MHz)	-	1350			•	(# <u>)</u>			•	.	ļ			Ħ					Ħ			-1	.0	0	1.0	dB
C.T.1	Crosstalk 1 (f=50MHz)	OUT(29) OUT(32)	2bSG3 6a 11a	а	a	a 5V	а	а	a	Vari able		FFH 255													-25	-20	dB
C.T.1'	Crosstalk 1 (f=200MHz)	OUT(29) OUT(32)	2bSG3 6a 11a	а	а	a 5V	а	а	а	Vari able													-		-15	-10	dB
C.T.2	Crosstalk 2 (f=50MHz)	OUT(29) OUT(35)	2a 6bSG3 11a	а	а	a 5V	а	а	а	Vari able	5.0														-25	-20	dB
C.T.2'	Crosstalk 2 (f=200MHz)	OUT(29) OUT(35)	2a 6bSG3 11a	а	а	a 5V	а	а	а	Vari able	5.0											\parallel			-15	-10	dB
C.T.3	Crosstalk 3 (f=50MHz)	OUT(32) OUT(35)	2a 6a 11bSG3	а	а	a 5V	а	а	а	Vari able	5.0		Ц									\parallel		-Nr	-25	-20	dB
C.T.3'	Crosstalk 3 (f=200MHz)	OUT(32) OUT(35)	2a 6a 11bSG3	а	a	a 5V	а	а	а	Vari able		V	l v	V		Į,		·		+					-15	-10	dB



BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

ELECTRICAL CHARACTERISTICS (cont.)

		Test				Input					TL lage					BU	IS	СТ	L (H)						Limits	3	
Symbol	Parameter	point (s)	2,6,11 RGB in	1 OSD BLK	4,9,13 OSD in	19 CP in	27 ReT BLK	7 SOG in	16 UNI in	30 Bri- ght	15 ABL	00H Main cont	O1H Sub con	Su	nt o	ub C		O5H BLK Adj		07H 007 007 2	D/A	O I	A L	HE TX	Min.	Тур.	Мах.	Unit
Tr	Pulse characteristics1 (4VP-P)	OUT	b SG1	а	a	b SG5	a	a	а	Vari		Va ria ble										Ī				1.7	-	ns
Tf	Pulse characteristics2 (4V _{P-P})	OUT	b SG1	а	а	b SG5	а	а	а	Vari able		Va ria ble													•	2.2	-	ns
ΔTr	Relative pulse characteristics1	ОИТ	b SG1	а	а	b SG5	a	а	а	Vari able		Vari able		П			П	T			П	T			-0.8	0	0.8	ns
ΔTf	Relative pulse characteristics2	OUT	b SG1	а	a	b SG5	а	а	а	Vari	5.0	Vari able		П			П	T			П	T	1		-0.8	0	0.8	ns
VthCP	Clamp pulse threshold voltage	оит	b SG1	a	a	b SG5 Variable	a	а	а	2.0	5.0	FFH 255													1.0	1.5	2.0	v
WCP	Clamp pulse minimum width	оит	b SG1	а	а	b SG5 Variable	а	а	а	2.0	5.0														0.2	0.5	-	μѕ
OTr	OSD pulse characteristics1	OUT	a	а	b SG6	b SG5	а	а	а	2.0	5.0	П	П	П	T		6H 8			П	П	Ī				3.0	6.0	ns
OTf	OSD pulse characteristics2	ОИТ	а	а	b SG6	b SG5	а	a	a	2.0	5.0	I	T	Ħ	T		8H 8	T	\dagger		\parallel	T				3.0	6.0	ns
Oaj1	OSD adjust control characteristics1	OUT	а	b SG6	b SG6	b SG5	а	a	a	2.0	5.0	П	T	Ħ	T		FH 15	Ħ	T	I	Ħ	T	Ť		4.6	5.4	6.2	VP-P
∆Oaj1	OSD adjust control relative characteristics1		1(+)	-	-				-		•				T		-	Ħ	T		Ħ		T		0.8	1.0	1.2	
Oaj2	OSD adjust control characteristics2	OUT	a	b SG6	b SG6	b SG5	а	а	a	2.0	5.0			П	T		8H 8			П	П	П	T		2.8	3.3	3.8	VP-P
∆Oaj2	OSD adjust control relative characteristics2	-	13.51	(- (-				-		•					1									0.8	1.0	1.2	
OBLK	OSD adjust control characteristics3	OUT	а	b SG6	а	b SG5	а	a	а	2.0	5.0			П		0	0H 0	П			П		T		0	-0.1	-0.3	VP-P
ΔOBLK	OSD adjust control relative characteristics3	-	•	•	-		-	-			100				I										-0.2	0	0.2	VP-P
VthOSD	OSD input threshold voltage	OUT	а	b SG6	b SG6 Variable	b SG5	а	а	а	2.0	5.0					٥	8H 8								2.2	2.7	3.2	٧
VthBLK	OSD BLK input threshold voltage	оит	b SG1	b SG6 Variable	а	b SG5	а	а	а	2.0	5.0		200			0	0H	V							2.2	2.7	3.2	V
HBLK1	Retrace BLK characteristics1	OUT	а	а	a	b SG5	sG7	a	а	2.0	5.0			П				0FH 15				П			1.7	2.0	2.3	٧
HBLK2	Retrace BLK characteristics2	OUT	а	a	а	b SG5	sG7	а	а	2.0	5.0			П			Π	06H 6			П				0.7	1.0	1.3	٧
HBLK3	Retrace BLK characteristics3	OUT	а	а	а	b SG5	b SG7	а	а	2.0	5.0				T		П	0			П	П			0.1	0.4	0.7	٧
VthRET	Retrace BLK input threshold voltage	OUT	а	а	а	b SG5	b SG7 Variable	а	а	2.0	5.0	٧	-	ļ	,	, ,		08H 8		V	ļ		,	,	1.0	1.5	2.0	٧
SS-NV	SOG input maximum noise voltage	SonG IN Sync OUT	а	а	a	а	a	b SG4 Variable	а	2.0	5.0														-		0.02	VP-P
ss-sv	SOG minimum input voltage	SonG IN Sync OUT	а	а	а	а	а	b SG4 Variable	а	2.0	5.0														0.2	0.3		Vp.p
VSH	Sync output hi level	Sync OUT	а	а	а	а	а	b SG4	а	2.0	5.0							1							4.5	4.9	5.0	٧
VSL	Sync output lo level	Sync OUT	а	а	а	а	а	b SG4	а	2.0	5.0					T		1							0	0.3	0.6	٧
TDS-F	Sync output delay time1	Sync OUT	а	а	а	а	а	b SG4	а	2.0	5.0			Г		T						Г	T		0	60	90	ns



ELECTRICAL CHARACTERISTICS (cont.)

		Test		10.725	98	Input				0.655	TL age				В	us	СТ	L (H)					Limits	3	
Symbol	Parameter	point (s)	2,6,11 RGB in	1 OSD BLK	4,9,13 OSD in	19 CP in	27 ReT BLK	7 SOG in	16 UNI in	30 Bri- ght	15 ABL	00H Main cont	01H Sub conf	02H Sub cont 2	Sub cont 3	04H OSD Adj	05H BLK Adj	06H D/A OUT	07H D/A OUT 2	D/A D/A OUT 3	09H D/A OUT 4	OBH INT EXT	Min.	Тур.	Мах.	Unit
TDS-R	Sync output delay time2	Sync OUT	а	а	а	а	а	b SG4	а	2.0	5.0												0	60	90	ns
VOH	D/A H output voltage	D/A OUT	а	а	а	а	а	а	а	2.0	5.0	FFH 255	FFH 255	FFH 255	FFH 255	00H 0	00H 0		FFH 255	FFH 255	FFH 255	00H	4.5	5.0	5.5	VDC
VOL	D/A L output voltage	D/A OUT	а	а	а	а	а	а	а	2.0	5.0				П	T		00H 0	00H 0	00H	00H	I	0	0.5	1.0	VDC
DNL	D/A nonlinearity	D/A OUT	а	а	a	а	а	а	а	2.0	5.0	•	V	V	V	П		Vari able	Vari able	Vari able	Vari able		-1.0		1.0	LSB
UNI1	Uniformity characteristics1	OUT	b SG1	а	а	b SG5	а	a	b SG6 2.5V	2.0	5.0	C8H 200	C8H 200	C8H 200	C8H 200			FFH 255	FFH 255	FFH 255	FFH 255		7	10	13	%
UNI2	Uniformity characteristics2	оит	b SG1	а	а	b SG5	а	a	b SG6 1.25V	2.0	5.0	Į.	V	Ţ	Ţ	Ų.	V	Ţ	V	Ţ	V	V	3.5	5	6.5	%
1A-	D/A input current range	D/A OUT	а	а	а	а	а	а	а	2.0	5.0	00H	00H 0	00H	00H	00H 0	00H 0	00H	00H 0	00H 0	00H 0	00H	0.18	-		mA
1A+	D/A output current range	D/A OUT	а	а	а	а	а	а	а	2.0	5.0	V	V	V	Ţ	Ų.	Ų.	V	1	V	V		-		1.0	mA

ELECTRICAL CHARACTERISTICS TEST METHOD

Icc1 Circuit current1

Measuring conditions are as listed in supplementary Table. Measured with a current meter at test point IA.

Icc2 Circuit current2

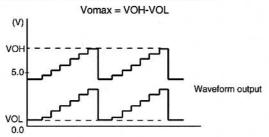
Measuring conditions are as listed in supplementary Table. Measured with a current meter at test point IB.

Vomax Output dynamic range

Decrease V30 gradually, and measure the voltage when the waveform output is distorted. The voltage is called VOL.

Next, increase V30 gradually, and measure the voltage when the top of waveform output is distorted. The voltage is called VOH.

Voltage Vomax is calculated by the equation below:



Vimax Maximum input

Increase the input signal (SG2) amplitude gradually, starting from 700mVP-P. Measure the amplitude of the input signal when the output signal starts becoming distorted.

Gv Maximum gain

Input SG1, and read the amplitude output at OUT (29, 32, 35). The amplitude is called VOUT (29, 32, 35). Maximum gain Gv is calculated by the equation below:

Gv=20Log
$$\frac{\text{VOUT}}{0.7}$$
 (dB)

∆Gv Relative maximum gain

Relative maximum gain ΔGv is calculated by the equation bellow:

ΔGv= VOUT (29)/VOUT (32), VOUT (32)/VOUT (35), VOUT (35)/VOUT (29)

Vc1 Main contrast control characteristics1

Measuring the amplitude output at OUT (29, 32, 35). The measured value is called VOUT (29, 32, 35). Main contrast control characterics Vc1 is calculated by the equation bellow:

ΔVc1 Main contrast control relative characteristics1

Relative characteristics $\Delta V\!c_1$ is calculated by the equation bellow:

ΔVc1=VOUT (29)/VOUT (32), VOUT (32)/VOUT (35), VOUT (35)/VOUT (29)

Vc2 Main contrast control characteristics2

Measuring condition and procedure are the same as described in $\ensuremath{\text{Vc1}}$.

ΔVc2 Main contrast control relative characteristics2

Measuring condition and procedure are the same as described in $\Delta V \text{c1}.$



Vc3 Main contrast control characteristics3

Measuring the amplitude output at OUT (29, 32, 35). The measured value is called VOUT (29, 32, 35).

∆Vc₃ Main contrast control relative characteristics3

Measuring condition and procedure are the same as described in AVc1.

Vsc₁ Sub contrast control characteristics1

Measure the amplitude output at OUT (29, 32, 35). The measured value is called VOUT (29, 32, 35). Sub contrast control characteristics Vsc₁ is calculated by the equation below:

$$Vsc1=20Log\frac{VOUT}{0.7} (dB)$$

ΔVsc1 Sub contrast control relative characteristics1

Relative characteristics $\Delta Vsc1$ is calculated by the equation below: $\Delta Vsc1=VOUT$ (29)/VOUT (32),

VOUT (32)/VOUT (35), VOUT (35)/VOUT (29).

Vsc2 Sub contrast control characteristics2

Measuring condition and procedure are the same as described in Vsc1.

∆Vsc₂ Sub contrast control relative characteristics2

Measuring condition and procedure are the same as described in ΔVsc_1 .

Vsc3 Sub contrast control characteristics3

Measuring the amplitude output at OUT (29, 32, 35). The measured value is called VSC3

∆Vsc3 Sub contrast control relative characteristics3

Measuring condition and procedure are the same as described in $\Delta \text{Vsc1}.$

VMSC Main/sub contrast control characteristics

Measure the amplitude output at OUT (29, 32, 35). The measured value is called VMSC

∆VMSC Main/sub contrast control relative characteristics

Relative characteristics $\Delta VMSC$ is calculated by the equation below:

ΔVMSC =VOUT (29)/VOUT (32), VOUT (32)/VOUT (35), VOUT (35)/VOUT (29)

ABL1 ABL control characteristics1

Measure the amplitude output at OUT (29, 32, 35). The measured value is called VOUT (29, 32, 35), and is treated as ABL1.

∆ABL1 ABL control relative characteristics1

Relative characteristics $\Delta ABL1$ is calculated by the equation below:

ΔABL1= VOUT (29)/VOUT (32), VOUT (32)/VOUT (35), VOUT (35)/VOUT (29)

ABL2 ABL control characteristics2

Measuring condition and procedure are the same as described in ABL1.

∆ABL2 ABL control relative characteristics2

Measuring condition and procedure are the same as described in $\Delta ABL1$.

VB1 Brightness control characteristics1

Measure the DC voltage at OUT (29, 32, 35) with a voltmeter. The measured value is called VOUT (29, 32, 35), and is treated as V B1.

∆VB1 Brightness control relative characteristics1

Relative characteristics ΔV_{B1} is calculated by the difference in the output between the channels.

ΔVB1= VOUT (29) -VOUT (32), VOUT (32) -VOUT (35), VOUT (35) -VOUT (29)

VB2 Brightness control characteristics2

Measuring condition and procedure are the same as described in V_{B1}.

∆VB2 Brightness control relative characteristics2

Measuring condition and procedure are the same as described in $\Delta \text{VB1}.$

VB3 Brightness control characteristics3

Measuring condition and procedure are the same as described in V_{B1} .

∆VB3 Brightness control relative characteristics3

Measuring condition and procedure are the same as described in ΔV_{B1} .



BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

Fc1 Frequency characteristics1 (f=50MHz)

First, SG3 to 1MHz is as input signal. Input a resister that is about $2k\Omega$ to offer the voltage at input pins (2, 6, 11) in order that the bottom of input signal is 2.5V. Control the main contrast in order that the amplitude of sine wave output is 4.0VP-P. Control the brightness in order that the bottom of sine wave output is 2.0VP-P. By the same way, measure the output amplitude when SG3 to 50MHz is as input signal. The measured value is called VOUT (29, 32, 35). Frequency characteristics Fc1 (29, 32, 35) is calculated by the equation below:

ΔFc1 Frequency relative characteristics1 (f=50MHz)

Relative characteristics ΔFc_1 is calculated by the difference in the output between the channels.

Fc1' Frequency characteristics1 (f=200MHz)

Measuring condition and procedure are the same as described in table, expect SG3 to 200MHz.

ΔFc1' Frequency relative characteristics1 (f=200MHz)

Relative characteristics $\Delta Fc1'$ is calculated by the difference in the output between the channels.

Fc2 Frequency characteristics2 (f=200MHz)

SG3 to 1MHz is as input signal. Control the main contrast in order that the amplitude of sine wave output is 1.0VP-P. By the same way, measure the output amplitude when SG3 to 200MHz is as input signal.

The measured value is called VOUT (29, 32, 35). Frequency characteristics Fc2 (29, 32, 35) is calculated by the equation below:

ΔFc2 Frequency relative characteristics2 (f=200MHz)

Relative characteristics ΔFc_2 is calculated by the difference in the output between the channels.

C.T.1 Crosstalk1 (f=50MHz)

Input SG3 (50MHz) to pin2 only, and then measure the waveform amplitude output at OUT (29, 32, 35). The measured value is called VOUT (29, 32, 35). Crosstalk C.T.1 is calculated by the equation below:

C.T.1' Crosstalk1 (f=200MHz)

Measuring condition and procedure are the same as described in C.T.1, expect SG3 to 200MHz.

C.T.2 Crosstalk2 (f=50MHz)

Input SG3 (50MHz) to pin6 only, and then measure the waveform amplitude output at OUT (29, 32, 35). The measured value is called VOUT (29, 32, 35). Crosstalk C.T.2 is calculated by the equation below:

C.T.2' Crosstalk2 (f=200MHz)

Measuring condition and procedure are the same as described in C.T.2, expect SG3 to 200MHz.

C.T.3 Crosstalk3 (f=50MHz)

Input SG3 (50MHz) to pin11 only, and then measure the waveform amplitude output at OUT (29, 32, 35). The measured value is called VOUT (29, 32, 35). Crosstalk C.T.3 is calculated by the equation below:

C.T.3' Crosstalk3 (f=200MHz)

Measuring condition and procedure are the same as described in C.T.3, expect SG3 to 200MHz.

Tr Pulse characteristics1 (4VP-P)

Control the main contrast (00H) in order that the amplitude of output signal is 4.0VP-P.

Control the brightness (V30) in order that the Black level of output signal is 2.0V.

Measure the time needed for the input pulse to rise from 10% to 90 % (Tr1) and for the output pulse to rise from 10% to 90% (Tr2) with an active probe.

Pulse characteristics Tr is calculated by the equations below:

$$Tr = \sqrt{(Tr2)^2 - (Tr1)^2}$$

∆Tr Relative pulse characteristics1

Relative characteristics ΔTr is calculated by the difference in the output between the channels.

Tf Pulse characteristics2 (4VP-P)

Measure the time needed for the input pulse to fall from 90% to 10% (Tf1) and for the output pulse to fall from 90% to 10% (Tf2) with an active prove.

Pulse characteristics Tf is calculated by the equations below:

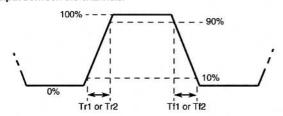
$$Tf = \sqrt{[(Tf2)^2 - (Tf1)^2]}$$



BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

∆Tf Relative pulse characteristics2

Relative characteristics ΔTf is calculated by the difference in the output between the channels.



VthCP Clamp pulse threshold voltage

Turn down the SG5 input level gradually from 5.0VP-P, monitoring the waveform output.

Measure the top level of input SG5 at when the output pedestal level is start to going down or unstable.

WCP Clamp pulse minimum width

Decrease the SG5 pulse width gradually from 0.5 µs, monitoring the output. Measure the input SG5 pulse width (at the point of 1.5V) at when output pedestal level is start to going down or unstable.

OTr OSD pulse characteristics1

Measure the time needed for the output pulse to rise from 10% to 90% (OTr) with an active prove.

OTf OSD pulse characteristics2

Measure the time needed for the output pulse to fall from 90% to 10% (OTf) with an active prove.

Oaj1 OSD adjust control characteristics1

Measure the amplitude output at OUT (29, 32, 35). The measured value is called VOUT (29,32,35), and is treated as Oaj1.

∆Oaj1 OSD adjust control relative characteristics1

Relative characteristics $\Delta \textsc{Oaj1}$ is calculated by the equation below:

ΔOaj1=VOUT (29)/VOUT (32),

VOUT (32)/VOUT (35),

VOUT (35)/VOUT (29)

Oaj2 OSD adjust control characteristics2

Measuring condition and procedure are the same as described in Oaj1.

∆Oaj2 OSD adjust control relative characteristics2

Measuring condition and procedure are the same as described in ΔOaj1 .

OBLK OSD adjust control characteristics3

Measuring condition and procedure are the same as described in Oai1.

∆OBLK OSD adjust control relative characteristics3

Measuring condition and procedure are the same as described in $\Delta Oaj1$.

VthOSD OSD input threshold voltage

Reduce the SG6 input level gradually, monitoring output. Measure the SG6 level when the output reaches 0V. The measured value is called VthOSD.

VthBLK OSD BLK input threshold voltage

Confirm that output signal is being blanked by the SG6 at the time. Monitoring to output signal, decreasing the level of SG6. Measure the top level of SG6 when the blanking period is disappeared. The measured value is called VthBLK.

HBLK1 Retrace BLK characteristics1

Measure the amplitude output is blanked by the SG7 at OUT (29, 32, 35). The measured value is called VOUT (29, 32, 35), and is treated as HBLK1.

HBLK2 Retrace BLK characteristics2

Measure the amplitude output is blanked by the SG7 at OUT (29, 32, 35). The measured value is called VOUT (29, 32, 35), and is treated as HBLK2.

HBLK3 Retrace BLK characteristics3

Measure the amplitude output is blanked by the SG7 at OUT (29, 32, 35). The measured value is called VOUT (29, 32, 35), and is treated as HBLK3.

VthRET Retrace BLK input threshold voltage

Confirm that output signal is being blanked by the SG7 at the time. Monitoring to output signal, decreasing the level of SG7. Measure the top level of SG7 when the blanking period is disappeared. The measured value is called VthRET.



SS-NV SOG input maximum noise voltage

The sync's amplitude of SG4 be changed all white into all black, increase from OVP-P to 0.02VP-P. No pulse output permitted.

SS-SV SOG minimum input voltage

The sync's amplitude of SG4 be changed all white or all black, decrease from 0.3VP-P to 0.2VP-P. Confirm no malfunction produced by noise.

VSH Sync output hi level

Measure the high voltage at SyncOUT. The measured value is treated as VSH.

VSL Sync output lo level

Measure the low voltage at SyncOUT. The measured value is treated as VSL.

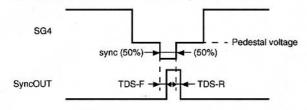
TDS-F Sync output delay time1

SyncOUT becomes High with sync part of SG4.

Measure the time needed for the front edge of SG4 sync to fall from 50% and for SyncOUT to rise from 50% with an active prove. The measured value is treated as TDS-F, less than 90nsec.

TDS-R Sync output delay time2

Measure the time needed for the rear edge of SG4 sync to rise from 50% and for SyncOUT to fall from 50% with an active prove. The measured value is treated as TDS-R, less than 90nsec.



VOH D/A H output voltage

Measure the DC voltage at D/AOUT. The measured value is treated as VOH.

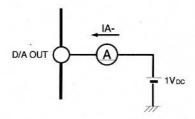
VOL D/A L output voltage

Measure the DC voltage at D/AOUT. The measured value is treated as VOL.

IAO D/A output current range

Electric current flow from the output of D/AOUT must be less than 1.0mA --- IA+.

Electric current flow into the output of D/AOUT must be more than 0.18mA --- IA-.



DNL D/A nonlinearity

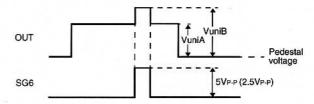
The difference of differential non-linearity of D/AOUT must be less than ±1.0LSB.

UNI1 Uniformity characteristics1

UNI2 Uniformity characteristics2

VuniA is amplitude output at OUT (29, 32, 35), when SG6 is low voltage. VuniB is amplitude output at OUT (29, 32, 35), when SG6 is high voltage.

moduration ratio UNI (UNI2) is calculated by the equation below;
UNI1 (UNI2)=100 • (VuniB/VuniA-1) (%)



BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

I²C-BUS PROTOCOL

(1) Slave address

D7	D6	D5	D4	D3	D2	D1	R/W	
1	0	0	0	1	0	0	0	=88H

(2) Slave receiver format

S	SLAVE ADDRESS	Α	SUB ADDRESS	Α	DATA BYTE	Α	Р
+		*		20-17-18			*
START cond	ition	acknowledge	• 3			ST	OP condit

(3) Sub address byte and data byte format

Function	bit	sub		Data	byte (top	:byte form	nat under:	start conc	lition)	
Function	DIL	add.	D7	D6	D5	D4	D3	D2	D1	D0
Main contrast	8	00H	A07	A06	A05	A04	A03	A02	A01	A00
Main contrast	•	UUH	0	1	0	0	0	0	0	0
Sub contrast R	8	01H	A17	A16	A15	A14	A13	A12	A11	A10
Sub contrast n	°	UIH	1	0	0	0	0	0	0	0
Sub contrast G	8	02H	A27	A26	A25	A24	A23	A22	A21	A20
Sub contrast G	0	UZH	1	0	0	0	0	0	0	0
Sub contrast B	8	03H	A37	A36	A35	A34	A33	A32	A31	A30
Sub contrast B	•	USH	1	0	0	0	0	0	0	0
OCD lavel	4	04H		-	700	-	A43	A42	A41	A40
OSD level	4	040	0	0	0	0	1	0	0	0
DE DI K adjust	4	05H	-	-	(5)	-	A53	A52	A51	A50
RE-BLK adjust	4	USH	0	0	0	0	1	0	0	0
D/A OUT1	8	06H	A67	A66	A65	A64	A63	A62	A61	A60
D/A OUT1	°	ООП	1	0	0	0	0	0	0	0
D/A OUT2	8	07H	A77	A76	A75	A74	A73	A72	A71	A70
D/A 0012	0	0/11	1	0	0	0	0	0	0	0
D/A OUT3	8	08H	A87	A86	A85	A84	A83	A82	A81	A80
DIA OUTS	8	ООП	1	0	0	0	0	0	. 0	0
D/A OUT4	8	09H	A97	A96	A95	A94	A93	A92	A91	A90
D/A 0014	8	0911	1	0	0	0	0	0	0	0
Podostal clamp INT/EVT SW		овн		-	-	-		-	-	ABO
Pedestal clamp INT/EXT SW	1	UBH	0	0	0	0	0	0	0	0

Notes) pedestal level INT/EXT SW

0 → INT 1 → EXT

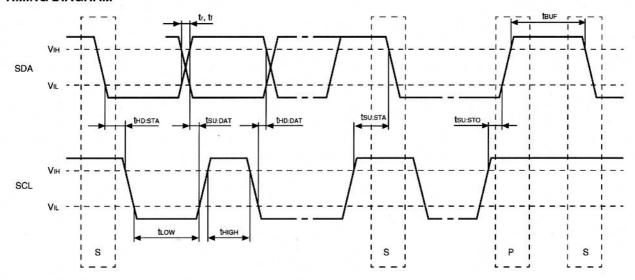
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TIMING REQUIREMENT OF I²C

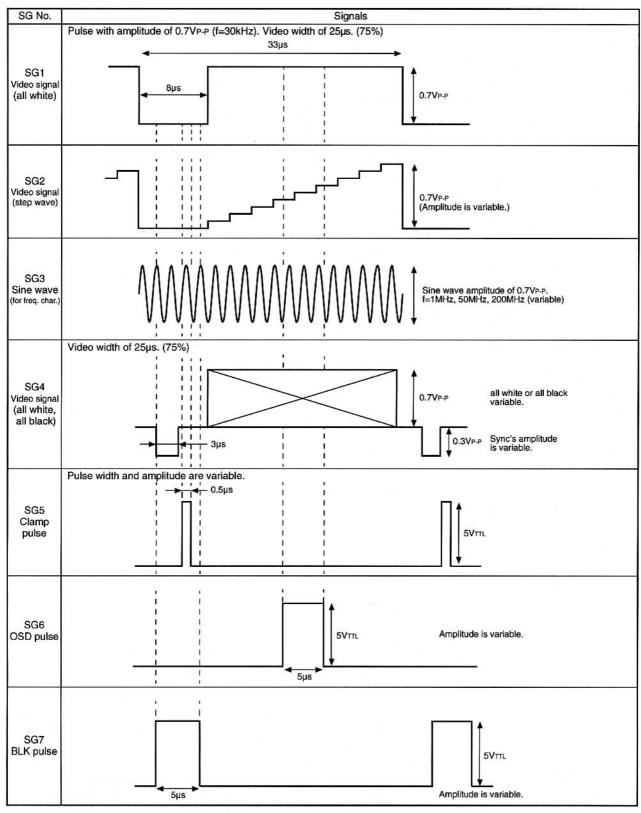
Symbol	Parameter	Min.	Max.	Unit
VIL	Input voltage LOW	-0.5	1.5	٧
Vін	Input voltage HIGH	3.0	5.5	٧
fscL	SCL clock frequency	0	100	kHz
tBUF	Time the bus must be free before a new transmission can start	4.7	-	μs
thd:STA	Hold time start condition. After this period the first clock pulse is generated	4.0	-	μs
tLOW	The LOW period of the clock	4.7	-	μs
thigh	The HIGH period of the clock	4.0		μs
tsu:sta	Set up time for start condition (Only relevant for a repeated start condition)	4.7	120	μs
thd:dat	Hold time for I ² C devices	0	-	μs
tsu:DAT	Set-up time DATA	250	- 2	ns
tr	Rise time of both SDA and SCL		1000	ns
tr	Fall time of both SDA and SCL		300	ns
tsu:sto	Set-up time for stop condition	4.0	12.5	μs

TIMING DIAGRAM



BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

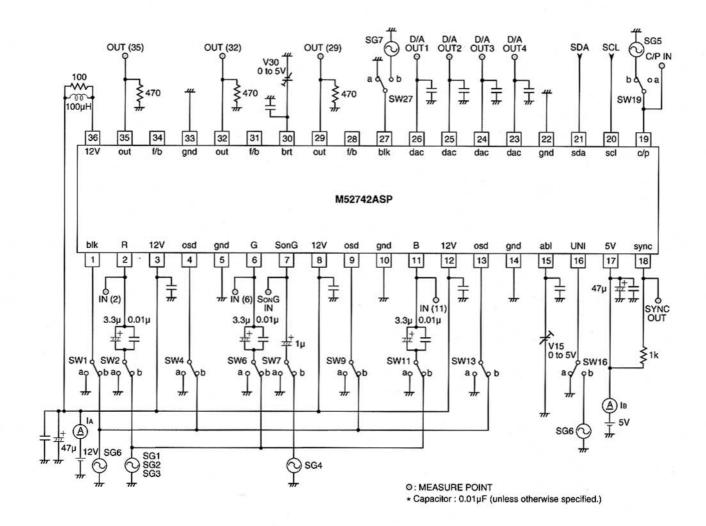
INPUT SIGNAL



*) f=30kHz



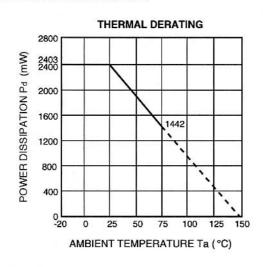
TEST CIRCUIT

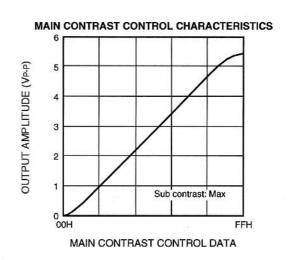


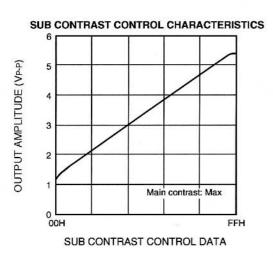
Units Resistance : Ω Capacitance : F

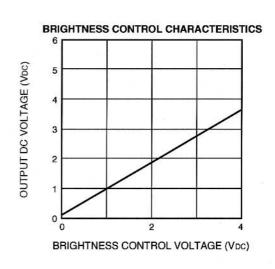
BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

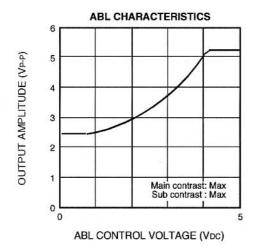
TYPICAL CHARACTERISTICS

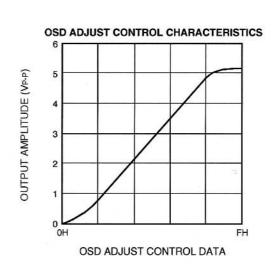




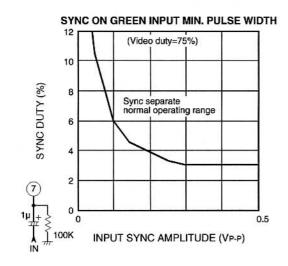


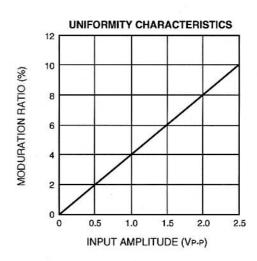




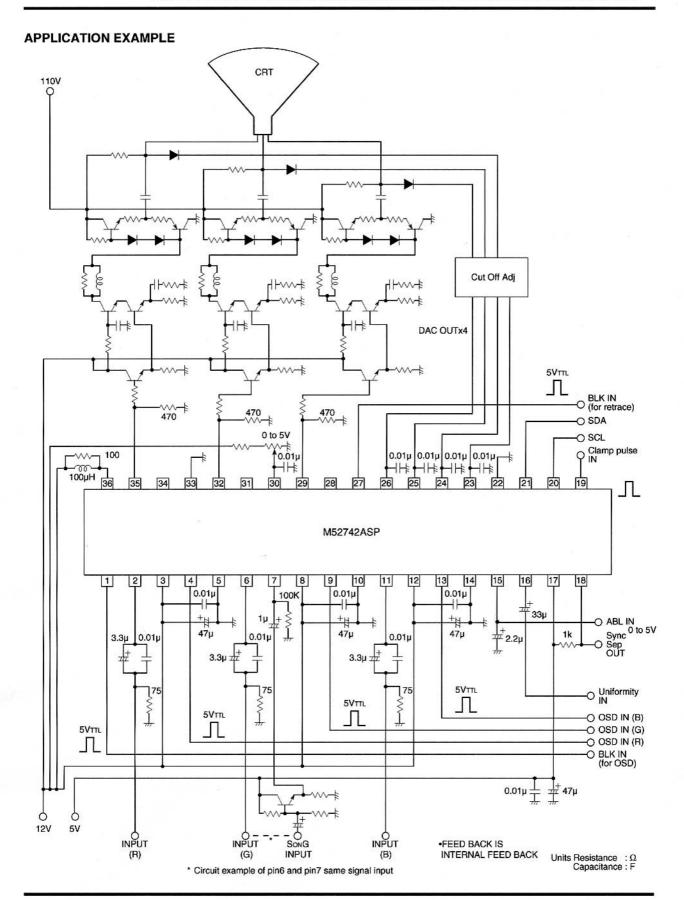


BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR





BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR



BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

DESCRIPTION OF PIN

Pin No.	Name	DC voltage (V)	Peripheral circuit of pins	Description of function
1	OSD BLK IN		1 2K B 2.7V 0.37mA 0.37mA	•Input pulses
2 6 11	INPUT (R) INPUT (G) INPUT (B)	2.5	2k	•Clamped to about 2.5V due to clamp pulses from pin 19. •Input at low impedance.
3 8 12	Vcc1 (R) Vcc1 (G) Vcc1 (B)	12	-	•Apply equivalent voltage to 3 channels.
4 9 13	OSD IN (R) OSD IN (G) OSD IN (B)	-	0.5mA 2.7V	•Input pulses 4 3.7 to 5V GND to 1.7V •Connected to GND if not used.
5 10 14 22 33	GND 1 (R) GND 1 (G) GND 1 (B) GND (5V) GND 2	GND	*	
7	INPUT (S on G)	When open 2.5V	0.22mA 0.15mA 0.22mA	•SYNC ON GREEN input pin for sync separation. Sync is negative. input signal at Pin7, compare with the reference voltage of internal circuit in order to separate sync signal. •When not used, set to OPEN.

BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

DESCRIPTION OF PIN (cont.)

Pin No.	Name Name	DC voltage (V)	Peripheral circuit of pins	Description of function
15	ABL IN	When open 2.5V	2.5V 2.5V 1.2k \$30k 0.5mA	•ABL (Automatic Beam Limiter) input pin. Recommended voltage range is 0 to 5V. When ABL function is not used, set to 5V.
16	Uniformity IN	5.75	7.25V 7 16 20k	•Uniformity input pin. Recommended amplitude range is 0 to 5VP-P.
17	Vcc (5V)	5		
18	S on G Sep OUT		18	•Sync signal output pin, Being of open collector output type.
19	Clamp Pulse IN	-	19 2.2V 0.15mA	•Input pulses
20	SCL		20 2k 3v	•SCL of PC BUS (Serial clock line) VTH=2.3V

BUS CONTROLLED 3-CHANNEL VIDEO PREAMP FOR CRT DISPLAY MONITOR

DESCRIPTION OF PIN (cont.)

Pin No.	Name	DC voltage (V)	Peripheral circuit of pins	Description of function
21	SDA	-	21 3V	•SDA of I ² C BUS (Serial data line) VTH=2.3V
23 24 25 26	D/A OUT	-	*	•D/A output pin. Output voltage range is 0 to 5V, Min input current is 0.18mA when D / A output pin is 1V. Max output current is 1.0mA.
27	Retrace BLK IN	-	50k R G B B 2.25V	•Input pulses 2.5 to 5V GND to 0.5V •Connected to GND if not used.
28 31 34	EXT Feed Back (B) EXT Feed Back (G) EXT Feed Back (R)	Variable	35k × × × × × × × × × × × × × × × × × × ×	
29 32 35	OUTPUT (B) OUTPUT (G) OUTPUT (R)	Variable	36) 50	•A resistor is needed on the GND side. Set discretionally to maximum 15mA, depending on the required driving capacity.
36	Vcc2	12	50	Used to supply power to output emitter follower only.

DESCRIPTION OF PIN (cont.)

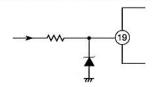
Pin No. Name	DC voltage (V)	Peripheral circuit of pins	Description of function
30 Main Brightness	-	35k ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥ ¥	•It is recommended that the IC be used between pedestal voltage 2V and 3V.

APPLICATION METHOD FOR M52742ASP

CLAMP PULSE INPUT Clamp pulse width is recommended above 15kHz, 1.0µsec above 30kHz, 0.5µsec above 64kHz, 0.3µsec.

The clamp pulse circuit in ordinary set is a long round about way, and beside high voltage, sometimes connected to external terminal, it is very easy affected by large surge.

Therefore, the Fig. shown right is recommended.

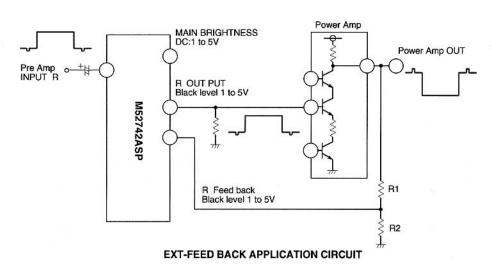


EXT-FEED BACK

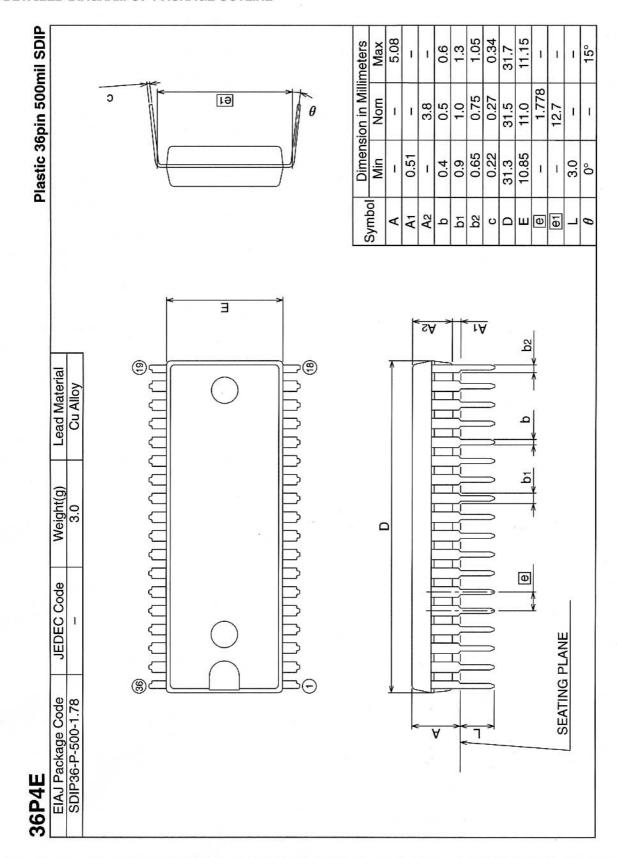
In case of application circuit example of lower figure, Set up R1, $\dot{R2}$ which seems that the black level of the signal feedbacked from Power AMP is 1V, when the bottom of output signal is 1V.

NOTICE OF APPLICATION

- Make the nearest distance between output pin and pull down resistor.
- Recommended pedestal voltage of IC output signal is 2V.



DETAILED DIAGRAM OF PACKAGE OUTLINE



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